

**Promote low-carbon industrial civilization**

**Co-create everything union with tin**

# **Shenzhen Anewbest Company Introduction**

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2. Core Technologies and Products
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## Company Profile



# 1.1 Company Introduction

**19<sup>+</sup> Years**

Focusing on intelligent precision soldering technology total solutions

**90%<sup>+</sup>**

90%+ market share of CCM solder ball laser soldering in China, is the leader in the laser tin soldering field

**10<sup>+</sup> Universities**

Cooperation with more than 10 universities to enrich the basic data, increase new technology application, enhance our core competitive advantages

**200<sup>+</sup> National patents**

**50<sup>+</sup> Patents for inventions**

National specialized, refinement, differential, innovation little giant, national high-tech, Shenzhen high-tech, double soft enterprise

**200<sup>+</sup> Employees**

31%+ R & D staff and 68% bachelor degrees

**500<sup>+</sup> Certificates**

4+ National standard and 3+ are technologies breakthrough



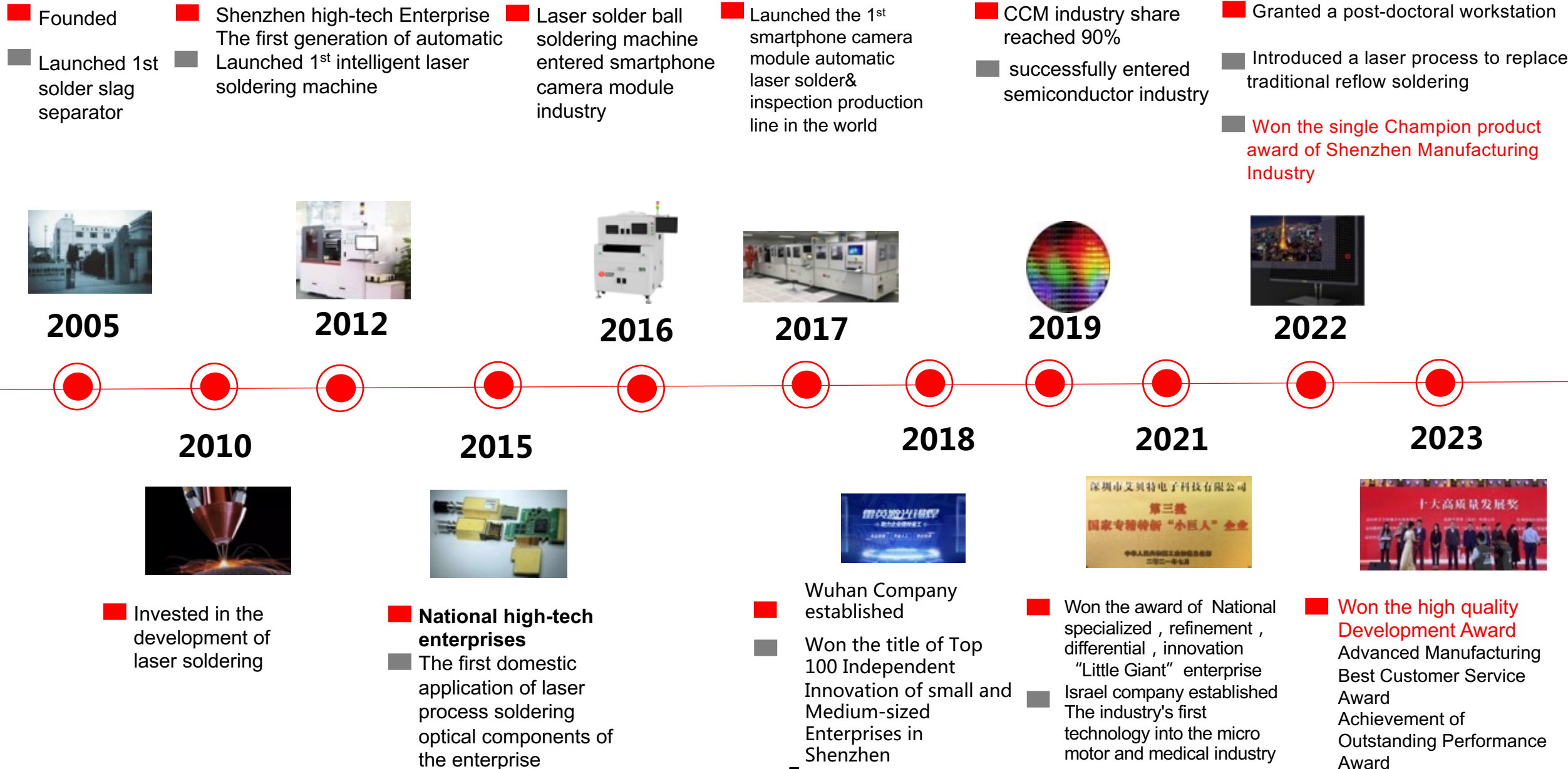
Founded in 2005, a total solution provider of global professional intelligent laser tin soldering integrated with R & D, assembly, sales and after-sales service.

19+ years deep research and development of tin soldering process, laser soldering theory and integration of precise machine with software and hardware. With our patented technologies and quality products, focusing on innovative ways to upgrade conventional tin soldering industry into a more environment friendly and cost competitive.

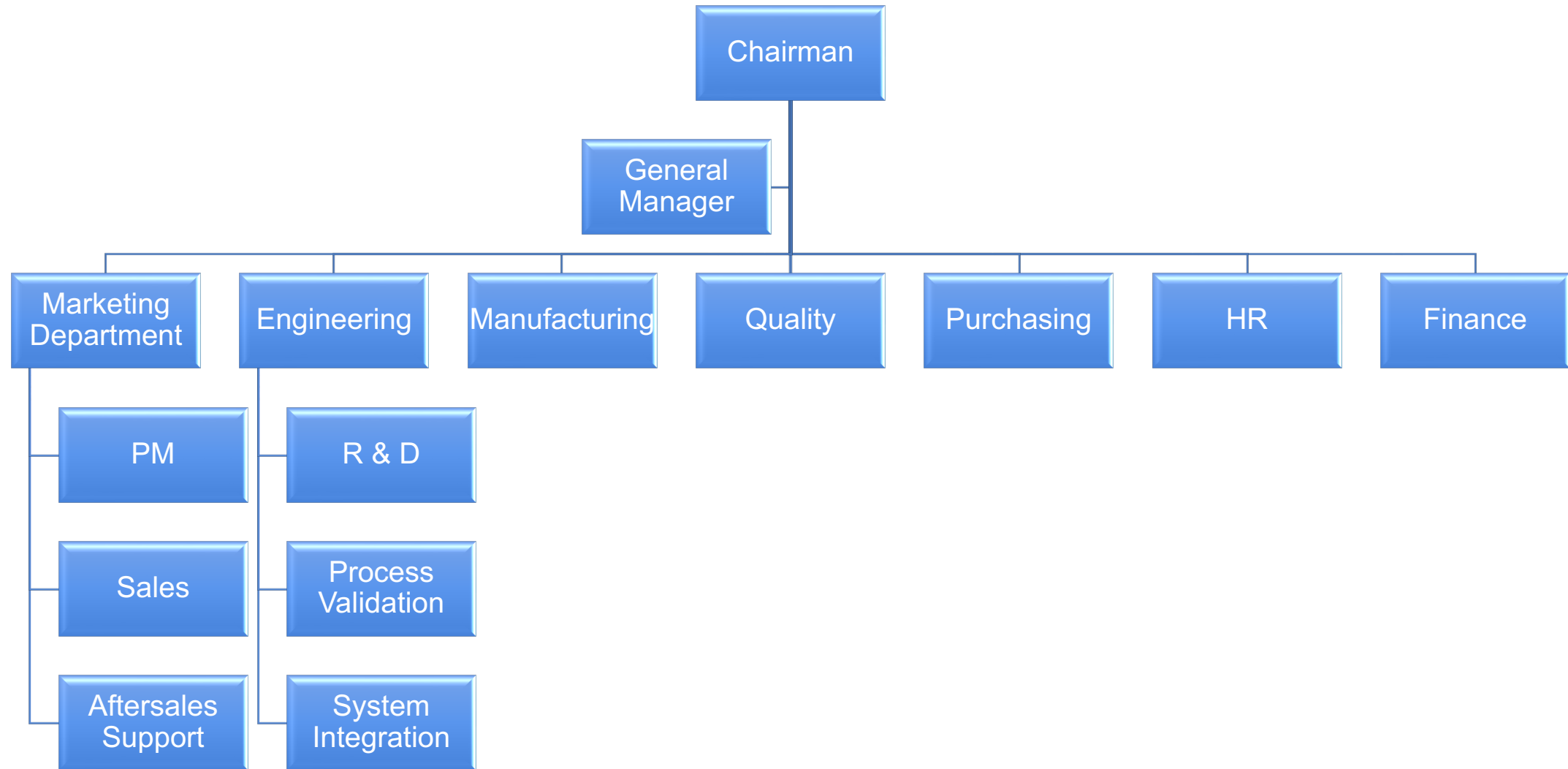
Providing customized laser soldering process total solution based on customer's soldering technical parameters and quality requirements.

Cooperated with 10+ domestic universities includes UESTC and Shenzhen University.

# 1.2 Main Development Milestones



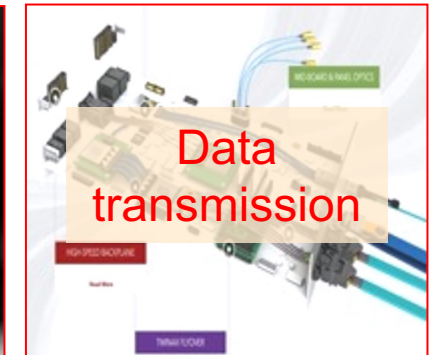
## 1.3 Company Organization Chart



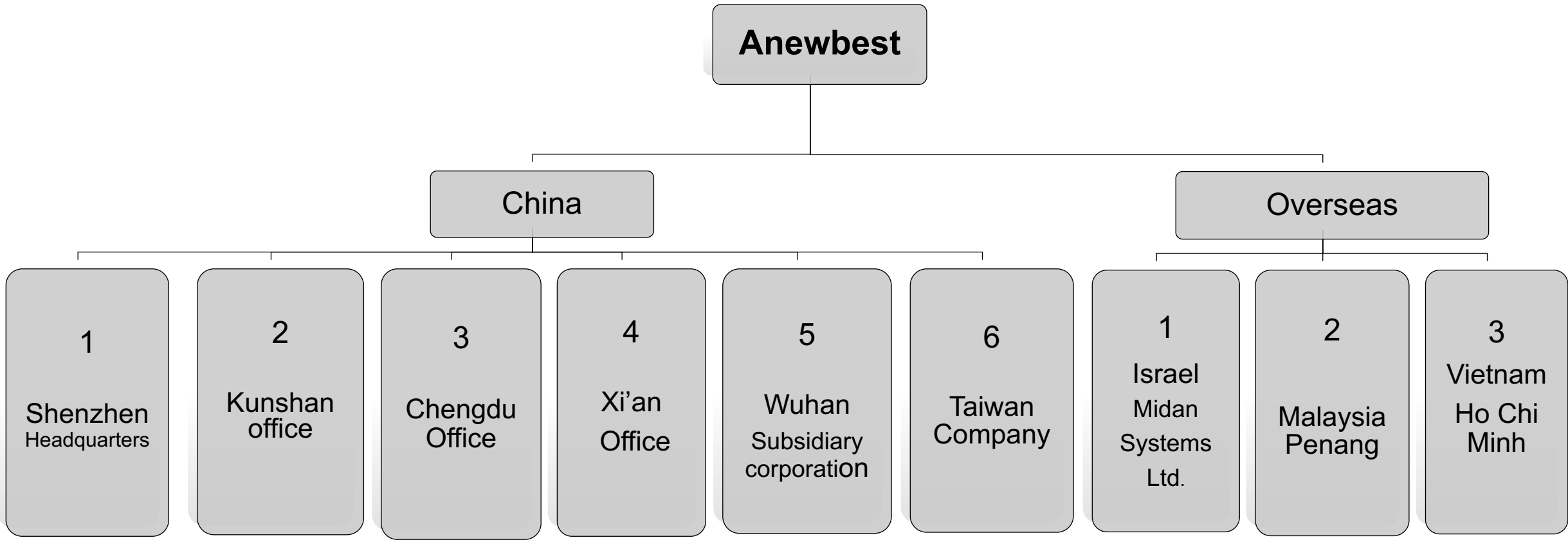
# 1.4 Business Scope and Industries

- Focus on intelligent precision laser soldering technology and total solutions

- Business scope covers high-precision, micro-precision of laser soldering process applications, integrates with automatic loading and unloading, visual inspection, dispensing, transferring, placement, barcode scanning , packaging and other process.
- Served industries includes consumer electronics, automotive electronics communications, medical electronics, semiconductor, high-speed transmission, high-end electronics and display (Mini-LED).

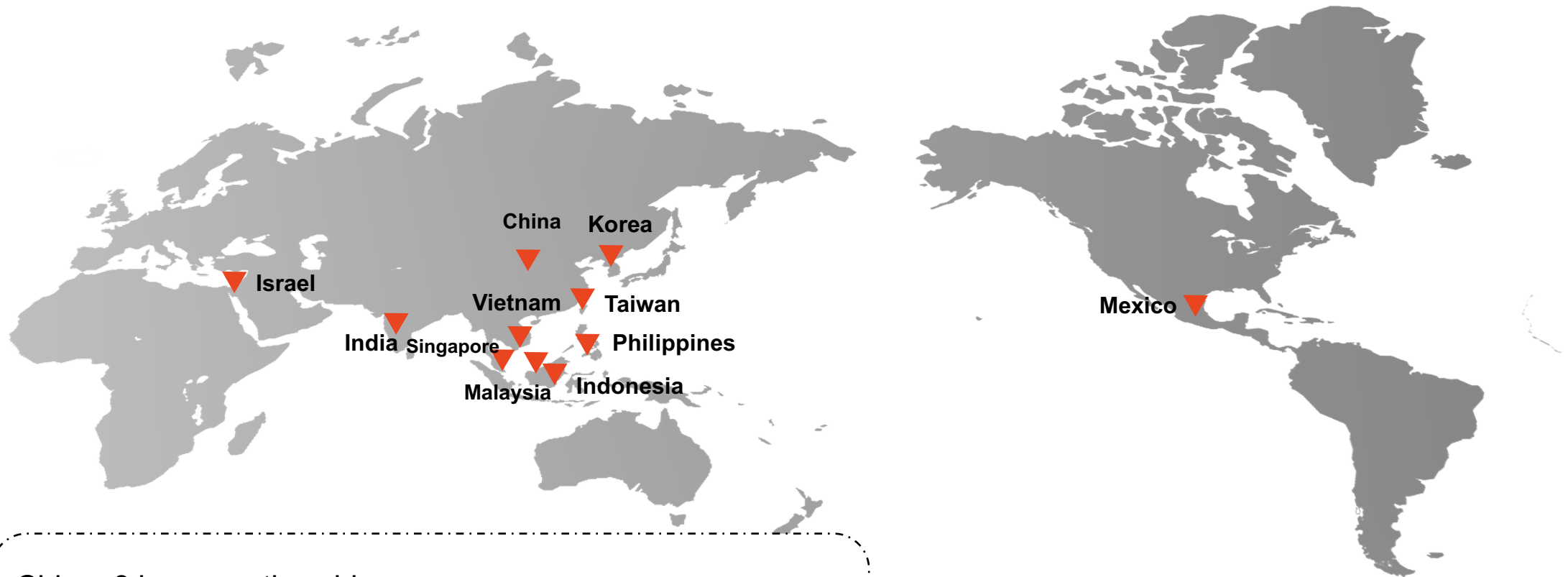


# 1.5 Headquarter and Branch Distribution



## 1.6 Global Aftersales Service Base Distribution

- Create worldwide network services and collaborate with clients to expand.



China: 6 bases nationwide  
Oversea: 11 service locations  
Total employees: 100+ employees  
Total delivered machine: 5000+ devices

# 1.7 Competitors Pro. and Con. Comparison

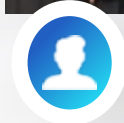
| Description                   | Anewbest                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | LGPRI                                                                                                                             | Laservall                                                                                                                                                                                                                                                                                                                              |
|-------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| R & D strength                | Sufficient and profound laser tin soldering process, tin element analysis and application development & research experience, strong know how capability, solid integrating capability of laser tin soldering process, customized automation machine.                                                                                                                                                                                                                                                                   | Good at optical design and laser pattern design. Good at laser tin wire soldering only. Take the advantages of giant corporation. | Good software development capability and large sales networks. Weak laser tin soldering process experience. Weak laser tin soldering total solution provider.                                                                                                                                                                          |
| Machine Features              | <ol style="list-style-type: none"> <li>1. Tray Auto-loading</li> <li>2. Auto-CCD identification &amp; positioning</li> <li>3. LASER Auto-soldering</li> <li>4. Solder joint AOI</li> <li>5. Solder PIN dispensing UV glue</li> <li>6. Optional FPC dispensing UV glue</li> <li>7. Post UV glue dispensing AOI</li> <li>8. Auto UV curing;</li> <li>9. Auto-sorting OK/NG &amp; unloading</li> <li>10. UPP ≥2500PCS @8PIN single side</li> <li>11. High flexibility for different types of product soldering</li> </ol> | Mainly focus servicing customer Samsung, combined with robot for their auto-soldering machine.                                    | <ol style="list-style-type: none"> <li>1. Auto-loading &amp; unloading</li> <li>2. Auto-CCD identification &amp; positioning</li> <li>3. LASER Auto-soldering</li> <li>4. Solder PIN dispensing UV glue</li> <li>5. 2D AVI</li> <li>6. Auto UV curing</li> <li>7. UPH 700 -800</li> <li>8. Customized &amp; low flexibility</li> </ol> |
| Machine stability             | <ol style="list-style-type: none"> <li>1. Yield 99.8% @2PIN</li> <li>2. Yield 99.5% @5PIN</li> <li>3. Yield 99.3% @19PIN</li> </ol>                                                                                                                                                                                                                                                                                                                                                                                    | Yield 99.5% @5PIN                                                                                                                 | Yield 99.5% @5PIN                                                                                                                                                                                                                                                                                                                      |
| Machine dimension             | Smallest                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | Bigger                                                                                                                            | Bigger                                                                                                                                                                                                                                                                                                                                 |
| Price                         | Lowest per UPH                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | Highest per UPH                                                                                                                   | Middle per UPH                                                                                                                                                                                                                                                                                                                         |
| After sales technical support | Laser tin soldering is our main business and have enough technical resource to provide support around the world. Smartphone camera laser soldering China market share ≥90%                                                                                                                                                                                                                                                                                                                                             | No China marketing share                                                                                                          | Mainly focusing on laser module sales and laser marking industry. Team members are not stable. Smartphone camera laser soldering China market share ≤5%                                                                                                                                                                                |
| Apple's AVL                   | No, but we've cooperated with partners and delivered ? sets laser tin soldering machines to Apple's CMs                                                                                                                                                                                                                                                                                                                                                                                                                | Yes, take this advantage a lot during competition                                                                                 | Yes, take this advantage a lot during competition                                                                                                                                                                                                                                                                                      |

## 1.8 Midan Systems Ltd (Israel)

MSL was established in 2020 stepping into the legacy and developed technology of **BeamWorks** Ltd.

Our team consists of experienced professionals in the field of Electronics Assembly Manufacturing. With deep expertise in technology development, product design, and market strategy, we are well-positioned to drive innovation and capture market share.

MSL recruited over the past 2 years a few team members experienced in Electronics Assembly Automation, Laser and Electro-Optics technologies.



**MIDAN SYSTEMS**

**Micha Sheffer**

FOUNDER & CEO



**Danny Schwartz**

CO-FOUNDER & COO



**Anewbest**

STRATEGIC PARTNER - EXCLUSIVE  
MANUFACTURER & SALES IN THE FAR EAST

## 1.9 Midan Systems Ltd (Israel)

### Our Solutions:

Our present products include the **Spark 400** and the **Selectiva Xi**.

Sold more than 100 units in the past.

Current status: Complete renewal to adapt to contemporary technology.



#### Selectiva Xi (Spark 100)

is an In-Line Selective laser soldering system designed for the mixed SMT / Through-hole assembly industry.

The system performs automatic and selective laser soldering of all types of through-hole components (connectors, large capacitors, odd-shaped electronic components).



#### Spark 400

is a multi-process assembly platform designed for assembling low-to-medium volume PCB lots, automatic rework, and prototype assembly.

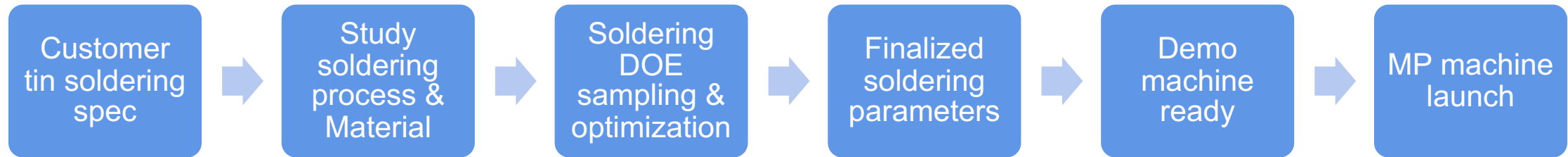
It concurrently performs paste dispensing, component placement and laser soldering without impacting already assembled components.

## 2. Core Technologies & Products



## 2.1 Core Technologies and Capabilities – Theory and Practice

With 18+ in-depth research and knowledge accumulation on the application of tin soldering process and knowledge of laser soldering's theory and characteristics, soldering requirement with different surface treatments, the knowledge of IPC standard and the successful delivery experience of many domestic and foreign tin soldering projects, we can customize the overall solution to meet customer's requirements for different soldering technical parameters and quality requirements, including tin material recipe, the selection of soldering process parameters, and provide constructive suggestions for the customer's product structure and process, and design and manufacture the laser soldering machine or automation line.



### Soldering method Options

1. Solder ball process
2. Solder paste process
3. Solder wire process

### Tin recipe options

1. SAC 305
2. Sn63/Pb37
3. Sn60/Pb40
4. Sn88/Pb12
5. Sn42/Bi57/Ag1
6. Sn99.3/Cu0.7

### Deliverables

1. CPK data
2. REL test result
3. Cross-section data
4. Drop test
5. Vibration test
6. X-ray inspection

## 2.2 Core Technologies and Capabilities – Valuable Assets

Granted 200+ patents and 50+ are invention patents, 90% are laser tin soldering related.

We established a good corporate image and provided us significant advantage over the competition, improved our technological research and development level.

| No. | Patent Type          | Patent Description                                                                        | Patent #         |
|-----|----------------------|-------------------------------------------------------------------------------------------|------------------|
| 1   | Invention Patent     | Laser soldering method and device for soldering materials composed of various elements    | 2016108649616    |
| 2   | Invention Patent     | Based on FPC Goldfinger laser soldering device and welding method                         | 2016108606517    |
| 3   | Invention Patent     | Laser jet soldering nozzle and jet soldering device &method                               | 2016108724176    |
| 4   | Invention Patent     | Handheld laser soldering device                                                           | 2017101571691    |
| 5   | Invention Patent     | Wet tin slag separation device and method                                                 | 2016108797938    |
| 6   | Invention Patent     | Fuse sleeve conveying device, system and method                                           | 201711173029X    |
| 7   | Invention Patent     | Fuse manufacturing device and method                                                      | 2017111737142    |
| 8   | Invention Patent     | Fuse unloading and fuse manufacturing device                                              | 2017111724439    |
| 9   | Invention Patent     | Fuse sleeve rotation device and method                                                    | 2017111730567    |
| 10  | Invention Patent     | Smartphone camera module soldering fixing device and method                               | 201810142544X    |
| 11  | Invention Patent     | Smartphone camera module soldering auto-fixing device                                     | 2018101420592    |
| 12  | Invention Patent     | Rapid positioning device based on Smartphone camera module soldering                      | 2018101425435    |
| 13  | Utility model patent | Laser soldering method and device for soldering materials composed of various elements    | 2016210959495    |
| 14  | Utility model patent | Based on FPC Goldfinger laser soldering device and welding method                         | 2016210934178    |
| 15  | Utility model patent | Handheld laser soldering device                                                           | 2017202580528    |
| 16  | Utility model patent | Laser jet soldering nozzle and jet soldering device &method                               | ZL 2016210946828 |
| 17  | Utility model patent | Wet tin slag separation device and method                                                 | ZL 2016211042549 |
| 18  | Utility model patent | Fuse sleeve conveying device, system and method                                           | 2017215716920    |
| 19  | Utility model patent | Fuse sleeve rotation device and method                                                    | 2017215817014    |
| 20  | Utility model patent | Smartphone camera module soldering auto-fixing device                                     | 2018202520907    |
| 21  | Utility model patent | Rapid positioning device based on Smartphone camera module soldering                      | 2018202520860    |
| 22  | Utility model patent | Automated tin-slag separator machine                                                      | ZL2006201546803  |
| 23  | Utility model patent | Wave soldering furnace with tin slag separator machine                                    | ZL2011205553883  |
| 24  | Utility model patent | IPM auto-soldering system for frequency conversion air conditioning main board            | ZL2012205516060  |
| 25  | Software copyright   | Electronic production management system for SMT machine V1.0                              | 2014SR175435     |
| 26  | Software copyright   | Induction cooker coil plate automatic intelligent soldering machine control software V1.0 | 2015SR063350     |
| 27  | Software copyright   | Automatic laser constant temperature control system V1.0                                  | 2019SR0935441    |
| 28  | Software copyright   | Automatic intelligent laser soldering control software V5.0                               | 2018SR582426     |

## 2.3 Core Technologies and Capabilities-Values to Customers

laser tin soldering offers significant advantages Vs conventional wave soldering or reflow in terms of precision, accuracy, energy consumption, environmental friendliness, material flexibility, customizability, contact method and suitability for high-end applications.

| No. | Description                   | Laser Tin Soldering                                                     | Selective Wave Soldering | Reflow         |
|-----|-------------------------------|-------------------------------------------------------------------------|--------------------------|----------------|
| 1   | <b>Precision and Accuracy</b> | High accuracy and precision for fine-pitch and miniaturized component   | Impossible               | Impossible     |
| 2   | <b>Energy consumption</b>     | 1-2 KW (laser power 75 – 200W)                                          | 2 - 10 KW                | 6 - 10KW       |
| 3   | <b>Cleaning process</b>       | No solder slag or waste, environmentally friendly                       | With Flux, need to clean | Depends        |
| 4   | <b>Material Flexibility</b>   | flexible parameters for wide range of materials and component types     | Limited solder           | Limited solder |
| 5   | <b>Customizable</b>           | Can focus on exact area                                                 | Not accurate             | No             |
| 6   | <b>Soldering CT</b>           | ≤10 ms                                                                  | 2-3s                     | 30 - 60s       |
| 7   | <b>Contact method</b>         | Contactless and stress free                                             | Contacted with stress    | With stress    |
| 8   | <b>High-End Applications</b>  | Applicable for precision and accuracy high-end electronic manufacturing | Impossible               | Impossible     |

## 2.4 Core Laser Soldering Scenarios

■ 18 + years of technology accumulation, focus on research and development, innovation in filed of laser soldering

**Laser solder ball**



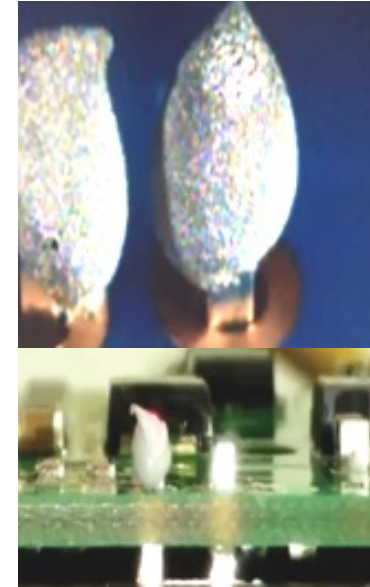
Applicable -SMD, precise and Mini-shaped products  
No flux nor clean, meet high reliability requirements.

**Laser solder wire**



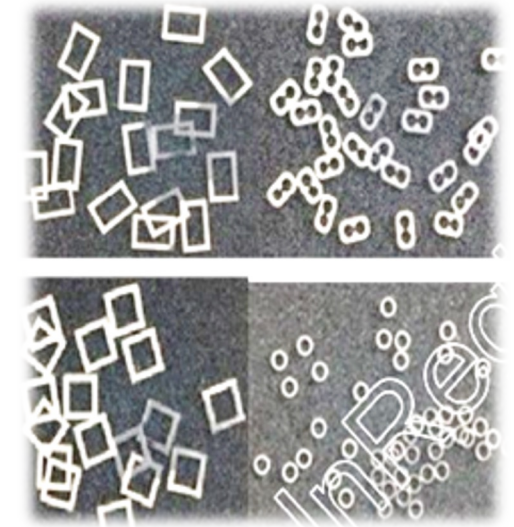
Applicable - THT component  
Consistent tin quantity, no process defects, low pollution, meet high reliability requirements, soldering temperature feedback.

**Laser solder paste**



Applicable - FPC, Cable, Connector  
Consistent tin shape, high compatibility, no process defects, low pollution, meet high reliability requirements, soldering temperature feedback.

**Laser solder preforming ring**

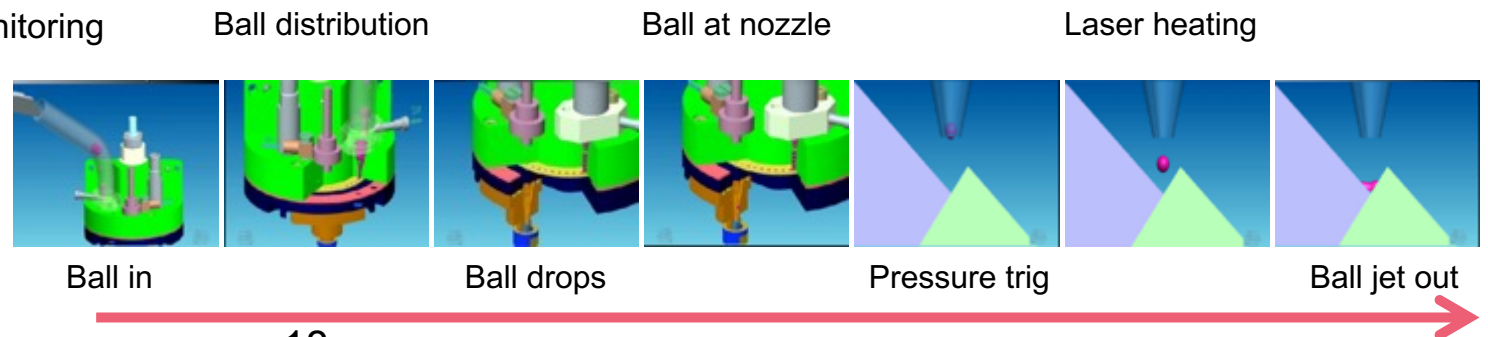


Applicable – Large gap between soldering pin and hole  
Good uniformity with general compatibility, no process defects, low pollution, meet high reliability requirements, soldering temperature feedback.

## 2.5 Products -- Laser Solder Ball Jet Machine

### Main parameters:

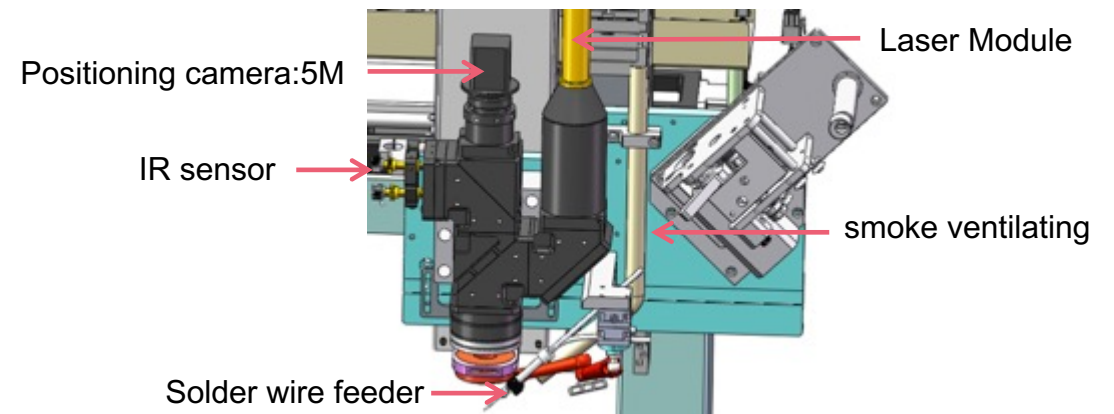
- ➔ Optical fiber laser wavelength: 1064 nm, power: 150 W
- ➔ CT of heating and melting process  $\leq 0.2s$ , no spattering during ball jetting
- ➔ Minimum diameter of the tin ball can be customized as small as 0.15mm
- ➔ Micrometer soldering precision and no contact soldering no stress force
- ➔ Different solder joints can be welded by selecting the size of the tin ball
- ➔ With CCD positioning system, repeatability precision is 0.02 mm
- ➔ Can equip 2 or 3 orbits per customer's UPH requirement
- ➔ Rotatable fixture allows soldering pads on different planes
- ➔ Lifetime of laser head 80,000 hours, nozzle 3,000,000 times
- ➔ Nitrogen to prevent oxidation and nitrogen flow monitoring
- ➔ No flux nor clean with smoke ventilating system
- ➔ Machine dimension: 1100 x 1000 X 1650 mm



## 2.6 Products -- Laser Solder Wire Soldering Machine

### Main parameters:

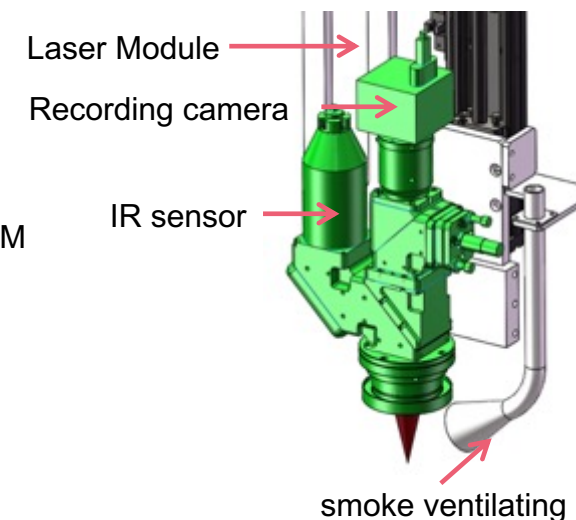
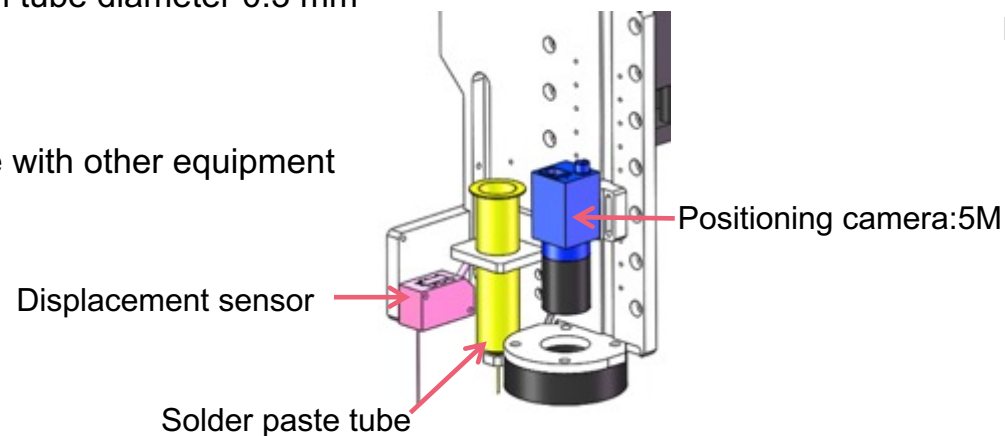
- ➔ Semiconductor laser wavelength: 915 nm, laser power: 80 - 200 W
- ➔ CT of heating and melting process 1- 2s,
- ➔ Minimum diameter of the tin wire can be 0.2 – 1.2 mm
- ➔ With CCD positioning system, repeatability precision is 0.02 mm
- ➔ No contact soldering no stress force
- ➔ The coaxial laser, CCD, temperature measuring and light guiding point provide real time temperature feedback and control between 100-600 °C, tolerance  $\leq 3$  °C
- ➔ Precise tin wire feed system?
- ➔ Modular design enabled singled machine or inline with other equipment
- ➔ Quipped with smoke ventilating system
- ➔ Machine dimensions: 1150 x 1050 X 1750 mm



## 2.7 Products -- Laser Solder Paste Soldering Machine

### Main parameters:

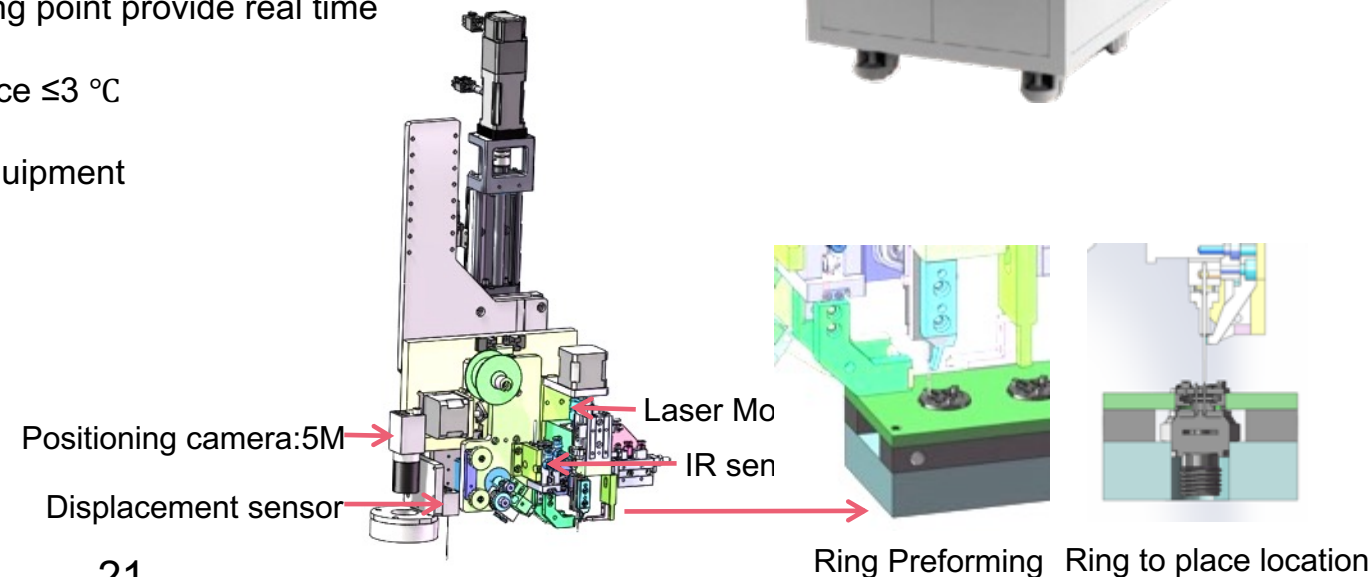
- ➔ Semiconductor laser wavelength: 915 nm, laser power: 100 W
- ➔ CT of heating and melting process 1- 2s,
- ➔ Equipped with solder paste height sensor, height tolerance  $\pm 0.002$  mm.
- ➔ With CCD positioning system, repeatability precision is 0.02 mm
- ➔ No contact soldering no stress force
- ➔ The coaxial laser, CCD, temperature measuring and light guiding point provide real time temperature feedback and control between 100-600 °C, tolerance  $\leq 3$  °C
- ➔ Precise solder paste dispensing system, minimum tube diameter 0.3 mm
- ➔ Lifetime of laser head >20,000 hours
- ➔ Modular design enabled singled machine or inline with other equipment
- ➔ Quipped with smoke ventilating system
- ➔ Machine dimensions: 1800 x 1310 X 1700 mm



## 2.8 Products -- Laser Solder Preforming Ring Soldering Machine *Anewbest*

### Main parameters:

- ➔ Semiconductor laser wavelength: 915 nm, laser power: 80 - 200 W
- ➔ Integrated ring preforming and laser soldering function into one machine
- ➔ CT of heating and melting process 1- 2s,
- ➔ Minimum diameter of the tin wire can be 0.2 – 1.2 mm
- ➔ With CCD positioning system, repeatability precision is 0.02 mm
- ➔ No contact soldering no stress force
- ➔ The coaxial laser, CCD, temperature measuring and light guiding point provide real time temperature feedback and control between 100-600 °C, tolerance  $\leq 3$  °C
- ➔ Modular design enabled singled machine or inline with other equipment
- ➔ Quipped with smoke ventilating system
- ➔ Machine dimensions: 1150 x 1050 X 1750 mm



## 2.9 Products – Camera Module Laser Solder Ball Jet Line

### Main parameters:

- UPH  $\geq 4000$ , Yield  $>99.5\%$ , integrated with loading and unloading mechanism.
- Minimum diameter of the tin ball can be customized as small as 0.15mm
- Different solder joints can be welded by selecting the size of the tin ball
- With CCD positioning system, repeatability precision is 0.02 mm
- Rotatable fixture allow soldering pads on different planes
- Lift time of laser head 80,000 hours, nozzle 3,000,000 times
- Quipped with smoke exhaust ventilating system
- Modular design flexible for different UPH requirements
- Nitrogen to prevent oxidation and nitrogen flow monitoring
- No Flux nor clean



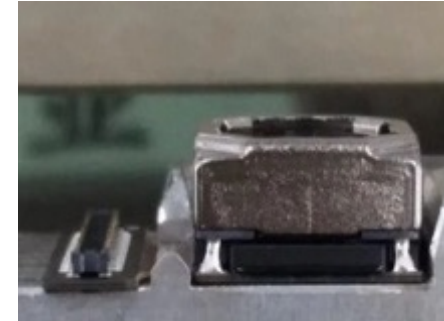
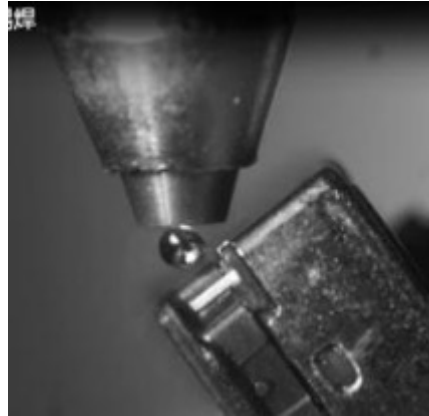
### 3. Applications in Industries



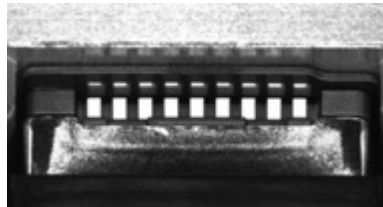
## 3.1 Consumer Electronics – Smartphone Camera Module

### ■ High UPH requirements

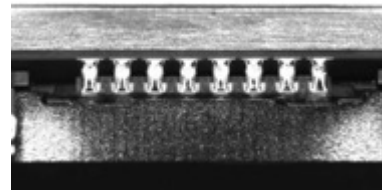
- ➔ Consistent tin amount
- ➔ No flux nor clean
- ➔ High yield >99.5%
- ➔ UPH: 4500
- ➔ Fully automation, no manual operation



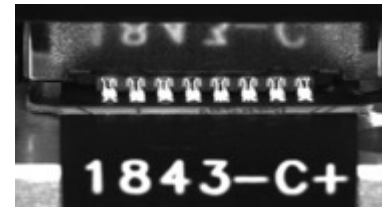
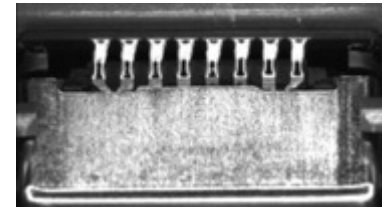
Before soldering



After soldering



After soldering



After soldering



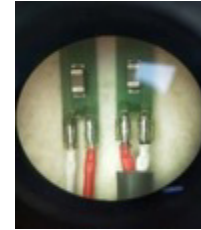
## 3.2 Automotive electronics --- Camera/Radar/Key

### ■ High reliability requirements

- ➔ The product can be miniaturized;
- ➔ Environment friendly, no flux nor clean
- ➔ The penetration rate of tin can reach 100%
- ➔ The pads on both sides are covered with tin
- ➔ The amount of tin is uniform and consistent



In-vehicle cameras



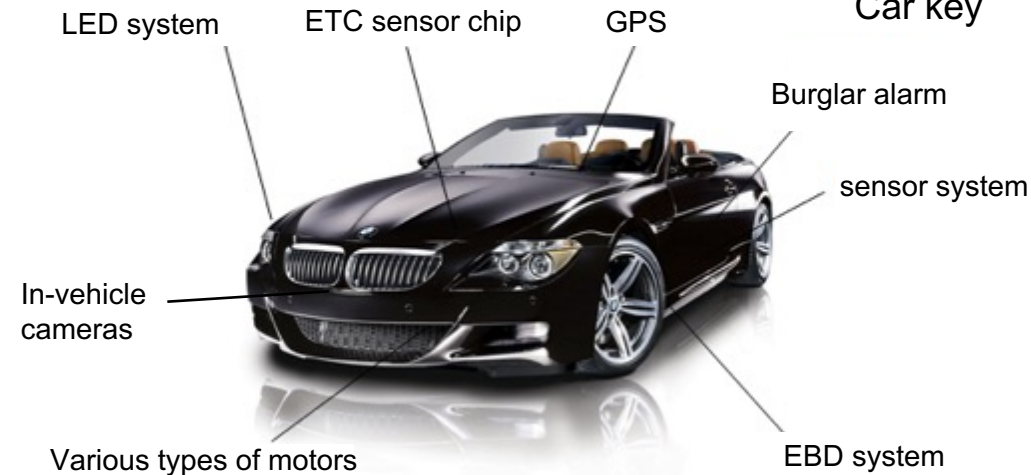
Temperature Sensor



Car key



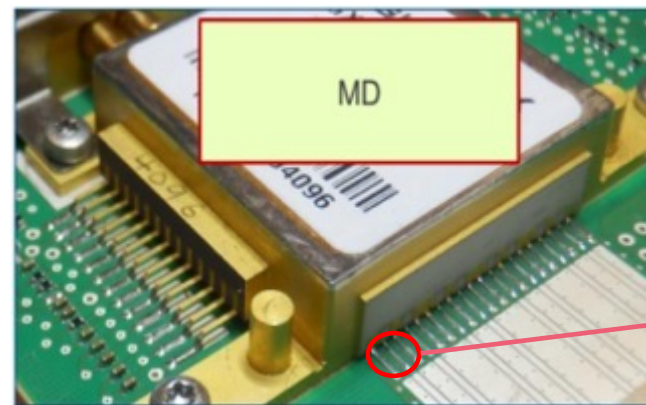
Car backing radar



## 3.3 Communications Industry --- RF Modules

- High reliability requirements
  - ➔ Meet device temperature resistant  $<75^{\circ}\text{C}$  requirement
  - ➔ Environment friendly, no flux nor clean
  - ➔ The amount of tin is uniform and consistent
  - ➔ Minimum pin pitch 0.2 mm
  - ➔ Yield rate is 99.5%+

Different function modules

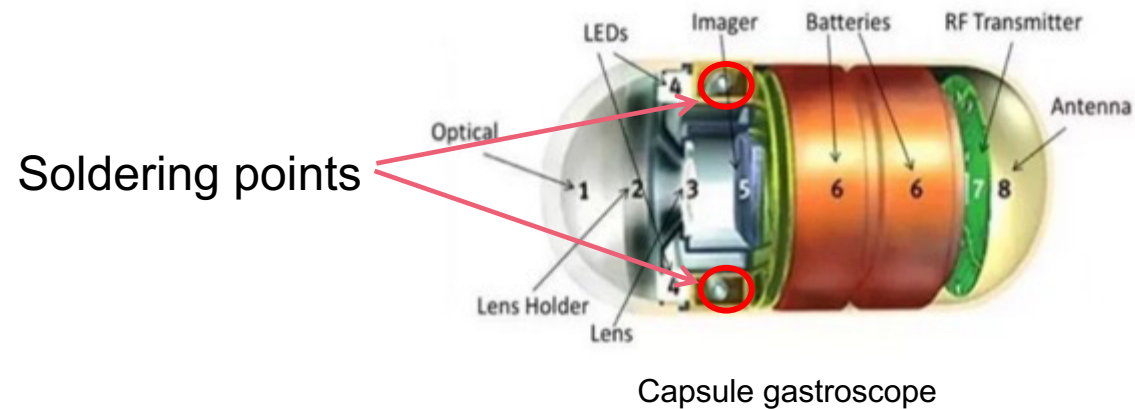
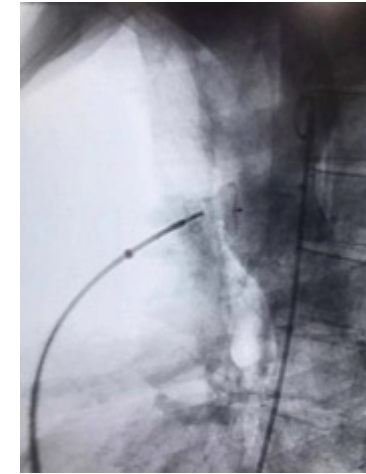


## 3.4 Medical Electronics --- Gastroscopy Endoscope

### ■ High reliability requirements

- ➔ Miniaturized size is applicable
- ➔ Environment friendly, no flux nor clean
- ➔ The penetration rate of tin can reach 100%
- ➔ The pads on both sides are covered with tin
- ➔ The amount of tin is uniform and consistent
- ➔ Yield rate is 99.9%+

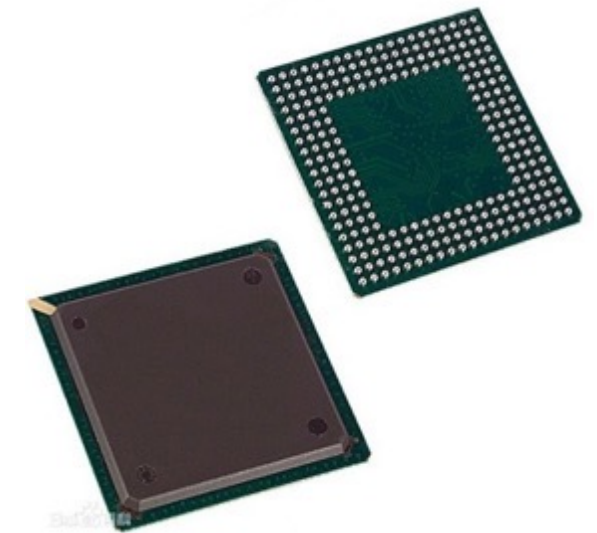
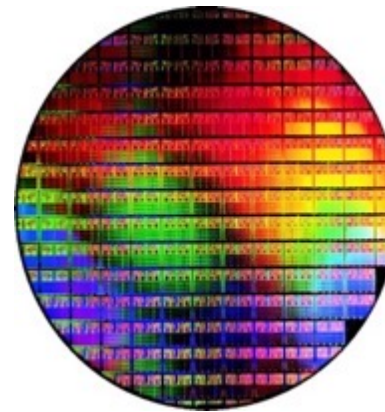
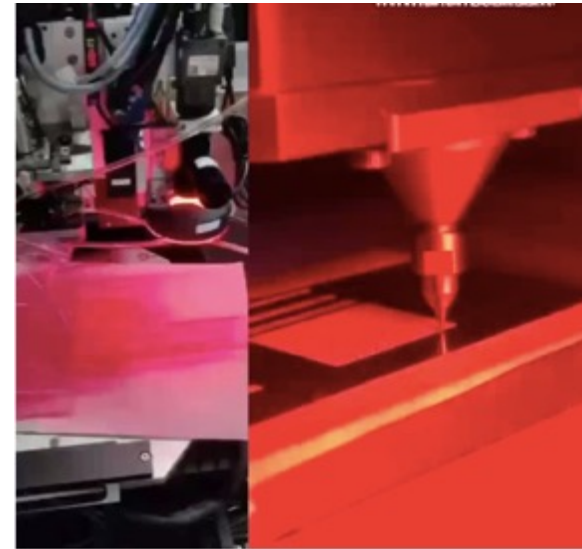
Gastroscopy, Colonoscopy, Cholangioscopic sensor Cardiopulmonary intervention sensor



## 3.5 Semiconductor Industry --- BGA ball planting

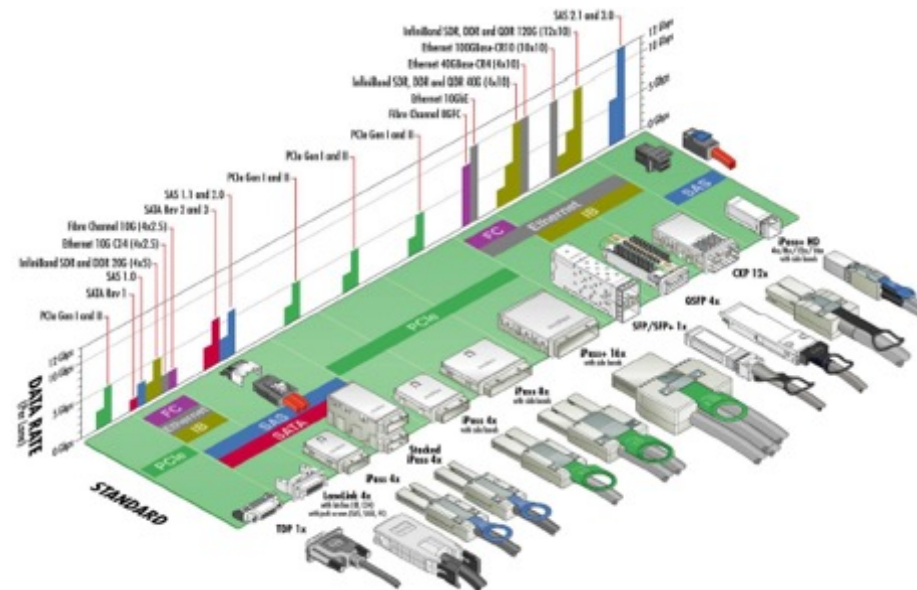
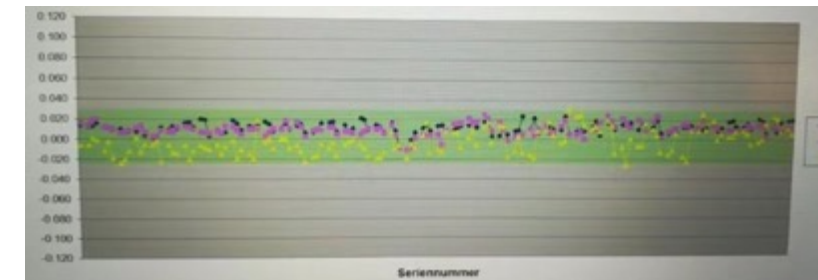
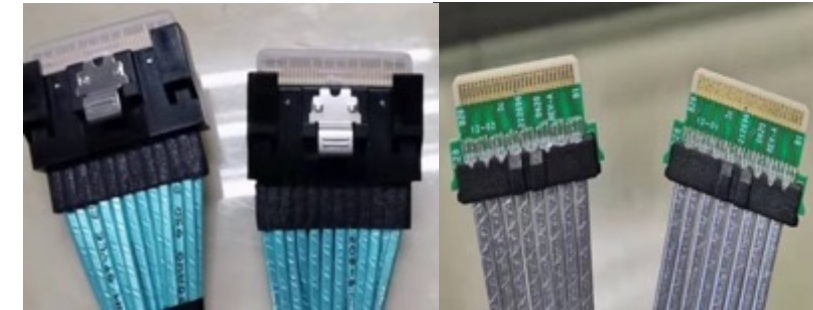
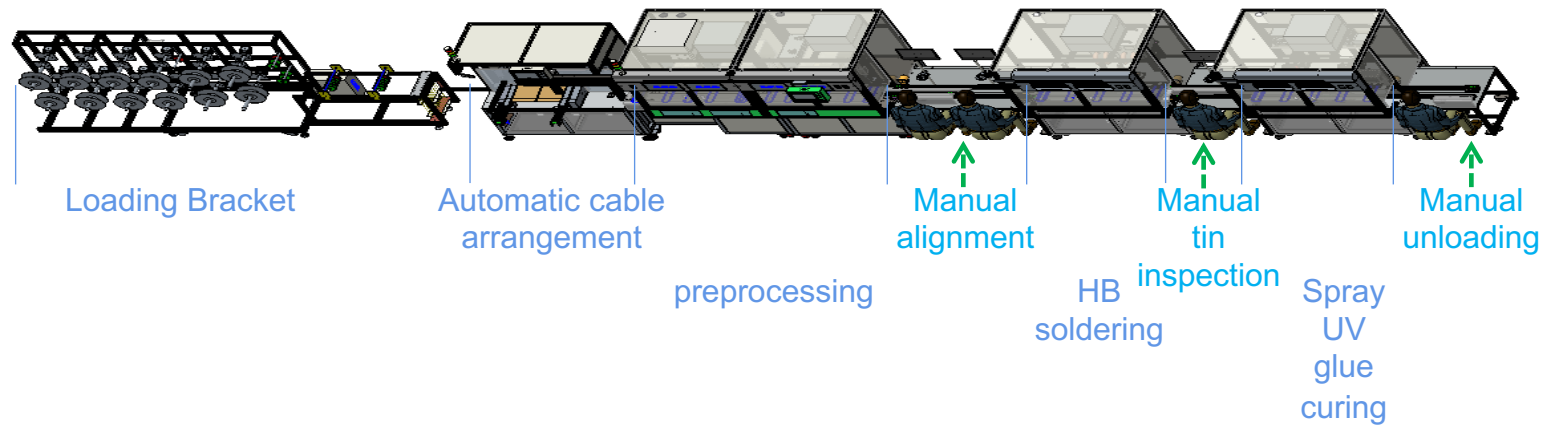
### ■ High reliability requirements

- ➔ CT of ball jetting 0.3 s
- ➔ Ball diameter: 0.1mm-0.76mm
- ➔ Minimum ball pitch: 0.1 mm
- ➔ Pad Surface treatment : gold-plated, tin-plated, silver-plated
- ➔ Environment friendly, no flux nor clean



### 3.6 High-Speed Transmission Industry- Cable and Connector

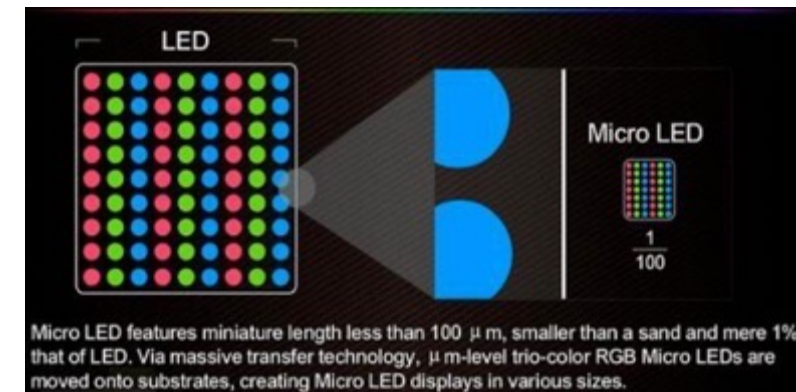
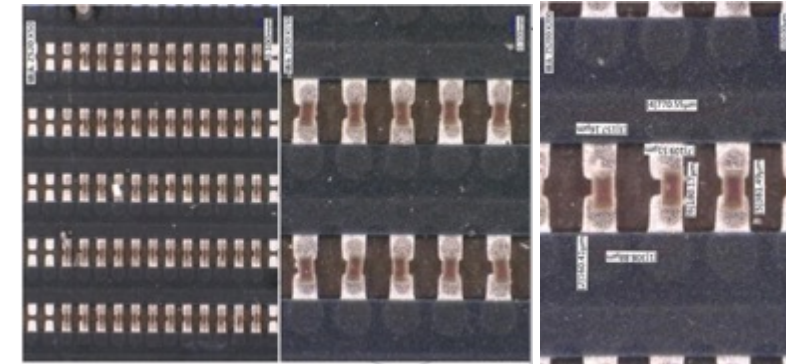
- High reliability requirements



## 3.7 Display Industry – Mini- LED

### ■ High reliability requirements

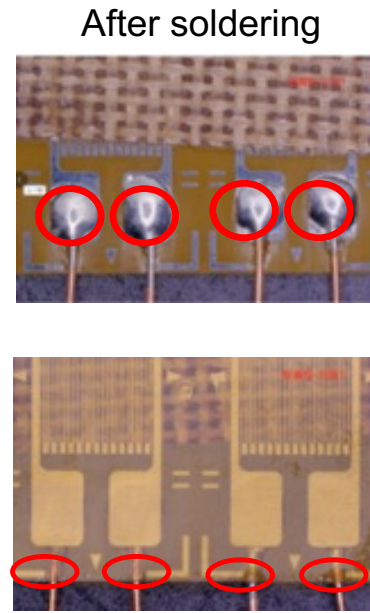
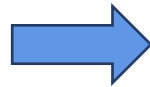
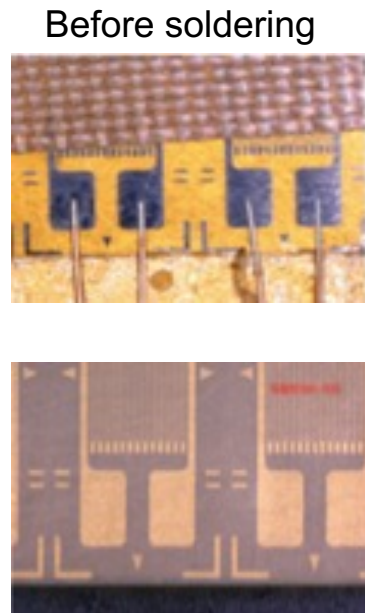
- ➔ Linear laser bar solder 15 pcs mini-LED chips simultaneously
- ➔ The coaxial laser, CCD, temperature measuring and light guiding point provide real time temperature feedback and control between 100-600 °C, tolerance  $\leq 3$  °C
- ➔ De-crystal, placement and laser soldering 3-in-one machine provide flexibility
- ➔ The combination of CCD positioning and die-bonding can find single or multi dies



## 3.8 Advanced Electronics Industry – Special Application

### ■ High investment efficiency requirements

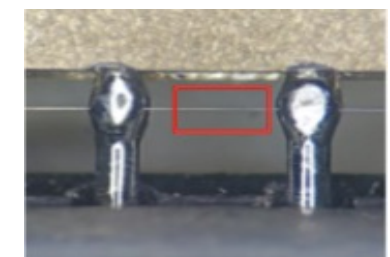
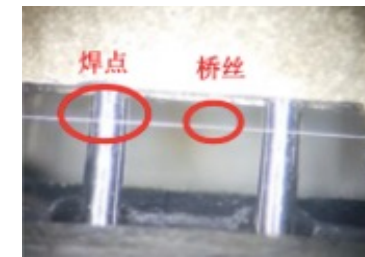
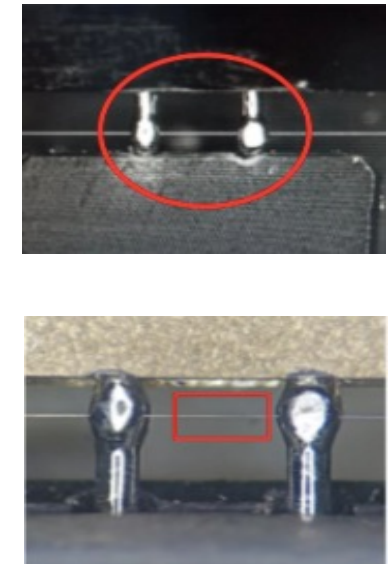
- ➔ Extreme tiny diameter 7um wire soldering
- ➔ Environment friendly, no flux nor clean
- ➔ The solders are hemisphere and smooth
- ➔ The amount of tin is uniform and consistent
- ➔ Yield rate is 99.9%+



Before soldering



After soldering



## 4. Main customers

FOXCONN<sup>®</sup>

Valeo  
法雷奥

JUMO

BOSCH

SAMSUNG

HUAWEI

JABIL

ZTE中兴

Honeywell

Canon

TDK

Panasonic

SUMITOMO  
ELECTRIC

LG

ankon  
INNOVATION FOR BETTER HEALTH

AOHUA  
澳华内镜

金山科技  
JINSHAN SCIENCE & TECHNOLOGY

5xLINK

舜宇光学科技  
SUNNY OPTICAL TECHNOLOGY

Q Tech

JOHNSON  
ELECTRIC

DELTA

LUXSHARE ICT  
立讯精密

LUXVISIONS  
Innovation Limited

USI<sup>®</sup>

OFILM 欧菲光

Txd 同兴达

top-Link  
Electronics

SHINA

福耀玻璃

## 5. Main Standard Part Partners

| No | Description      | Brand      | Location     | Remark                         |
|----|------------------|------------|--------------|--------------------------------|
| 1  | Laser module     | Customized | China        | 150W JDSUMAX Laser             |
| 2  | X,Y,Z module     | HIWIN      | China Taipei | X/Y/Z movement                 |
| 3  | Servo motor      | MITSUBISHI | Japan        |                                |
| 4  | PLC              | KEYENCE    | Japan        |                                |
| 5  | Cylinder         | SMC        | Japan        |                                |
| 6  | IPC              | EVOC       | China        |                                |
| 7  | CCD              | DaHeng     | China        | Capture soldering point        |
| 8  | Standard parts   | MISUMI     | Japan        |                                |
| 9  | LENS             | Canrill    | China        |                                |
| 10 | Display          | WEINVIEW   | China Taipei |                                |
| 11 | Optical fiber    | OMRON      | Japan        | Laser on and off communication |
| 12 | Electrical parts | SCHNEIDER  | France       |                                |
| 13 | Switch Power     | MEANWELL   | China Taipei |                                |

# Thanks!

**24 hours technical support.**  
**Customer first. Service first. Speed first. Satisfaction first!**



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